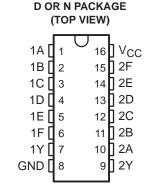
- Meets or Exceeds the Requirements of IBM™ System 360 Input/Output Interface Specification
- Operate From Single 5-V Supply
- TTL Compatible
- 3.11-V Output at I_{OH} = -59.3 mA
- Uncommitted Emitter-Follower Output Structure for Party-Line Operation
- Short-Circuit Protection
- AND-OR Logic Configuration
- Designed for Use With Triple Line Receiver SN75124
- Designed to Be Interchangeable With N8T13 and N8T23



THE SN751730 IS RECOMMENDED FOR NEW IBM 360/370 INTERFACE DESIGNS.

description

The SN75123 is a dual line driver specifically designed to meet the input/output interface specifications for IBM System 360. It also is compatible with standard-TTL logic and supply-voltage levels.

The SN75123 low-impedance emitter-follower outputs drive terminated lines such as coaxial cable or twisted pair. Having the outputs uncommitted allows wired-OR logic to be performed in party-line applications. Output short-circuit protection is provided by an internal clamping network that turns on when the output voltage drops below approximately 1.5 V. All the inputs are in conventional TTL configuration, and the gating can be used during power-up and power-down sequences to ensure that no noise is introduced to the line.

The SN75123 is characterized for operation from 0°C to 70°C.

FUNCTION TABLE

		INP	UTS	OUTPUT		
Α	В	С	D	E	F	Y
Н	Н	Н	Н	Х	Χ	Н
X	X	X	X	Н	Н	Н
	All ot	her input	combina	ations		L

H = high level, L = low level, X = irrelevant

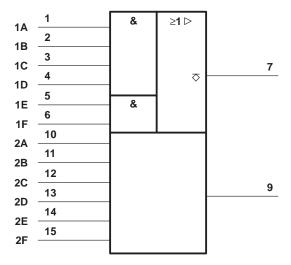


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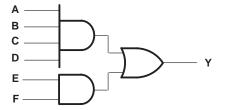


logic symbol†

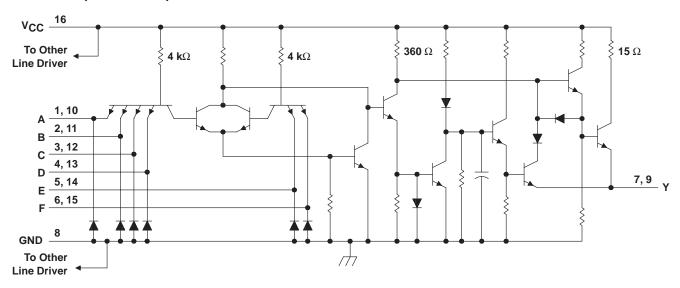


 $^{^\}dagger$ This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)



schematic (each driver)



Resistor values shown are nominal.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V _{CC} (see Note 1)	V
Input voltage, V _I	V
Output voltage, V _O	V
Continuous total dissipation at (or below) 25°C free-air temperature (see Note 2): D package 950 ml	W
N package 1150 m\	W
Operating free-air temperature range, T _A 0°C to 70°	°C
Storage temperature range, T _{stq} 65°C to 150°	°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

	MIN	NOM	MAX	UNIT
Supply voltage, V _{CC}	4.75	5	5.25	V
High-level input voltage, VIH	2			V
Low-level input voltage, V _{IL}			0.8	V
High-level output current, IOH			-100	mA
Operating free-air temperature, T _A	0		70	°C



NOTES: 1. All voltage values, except differential input voltage, are with respect to network ground terminal.

^{2.} For operation above 25°C free-air temperature, derate the D package to 608 mW at 70°C at the rate of 7.6 mW/°C and the N package to 736 mW at 70°C at the rate of 9.2 mW/°C.

electrical characteristics, V_{CC} = 4.75 V to 5.25 V, T_A = 0°C to 70°C (unless otherwise noted)

	PARAMETER	TEST	MIN	MAX	UNIT		
VIK	Input clamp voltage	V _{CC} = 5 V,	I _I = -12 mA			-1.5	V
V _{I(BR)}	Input breakdown voltage	V _{CC} = 5 V,	I _I = 10 mA		5.5		V
Va	High-level output voltage	V _{CC} = 5 V, V _{IH} = 2 V,	T _A = 25°C		3.11		V
VOH	High-level output voltage	$I_{OH} = -59.3$ mA, See Note 3	$T_A = 0$ °C to 70 °C	2.9		V	
VOL	Low-level output voltage	V _{IL} = 0.8 V,	$I_{OL} = -240 \mu A$,	See Note 3		0.15	V
ЮН	High-level output current	V _{CC} = 5 V, V _{IH} = 4.5 V, V _{OH} =	-100	-250	mA		
IO(off)	Off-state output current	$V_{CC} = 0$,	V _O = 3 V			40	μΑ
lн	High-level input current	V _I = 4.5 V				40	μΑ
Iμ	Low-level input current	V _I = 0.4 V			-0.1	-1.6	mA
los	Short-circuit output current†	V _{CC} = 5 V,	T _A = 25°C			-30	mA
ICCH	Supply current, outputs high	V _{CC} = 5.25 V,	All inputs at 2 V,	Outputs open		28	mA
ICCL	Supply current, outputs low	V _{CC} = 5.25 V,	All inputs at 0.8 V,	Outputs open		60	mA

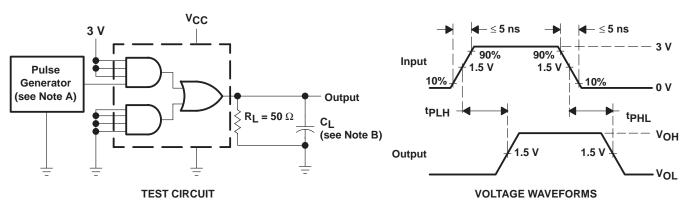
[†] Not more than one output should be shorted at a time.

NOTE 3: The output voltage and current limits are valid for any appropriate combination of high and low inputs specified by the function table for the desired output.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

	PARAMETER	1	MIN	TYP	MAX	UNIT		
tPLH	Propagation delay time, low- to high-level output	$R_L = 50 \Omega$,	C _L = 15 pF,	See Figure 1		12	20	ns
tPHL	Propagation delay time, high- to low-level output	$R_L = 50 \Omega$,	C _L = 15 pF,	See Figure 1		12	20	ns
tPLH	Propagation delay time, low- to high-level output	$R_L = 50 \Omega$,	C _L = 100 pF,	See Figure 1		20	35	ns
tPHL	Propagation delay time, high- to low-level output	$R_L = 50 \Omega$,	C _L = 100 pF,	See Figure 1		15	25	ns

PARAMETER MEASUREMENT INFORMATION



- NOTES: A. The pulse generator has the following characteristics: $Z_0 = 50 \Omega$, $t_w = 200 \text{ ns}$, duty cycle = 50%.
 - B. C_L Includes probe and jig capacitance.

Figure 1. Test Circuit and Voltage Waveforms



TYPICAL CHARACTERISTICS

OUTPUT CURRENT VS OUTPUT VOLTAGE -300 VCC = 5 V All inputs at 2 V -250 -250 -150 -100 -50 0 1 2 3 4 5 VO - Output Voltage - V

APPLICATION INFORMATION

Figure 2

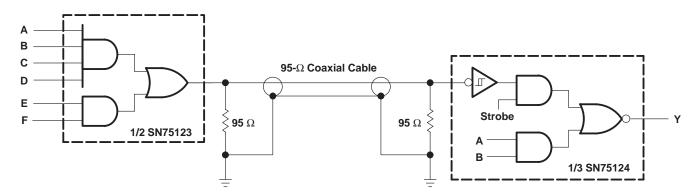


Figure 3. Unbalanced Line Communication Using SN75123 and SN75124



www.ti.com 17-Jun-2023

PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package Drawing		Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
							(6)				
SN75123N	LIFEBUY	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN75123N	

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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PACKAGE MATERIALS INFORMATION

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TUBE



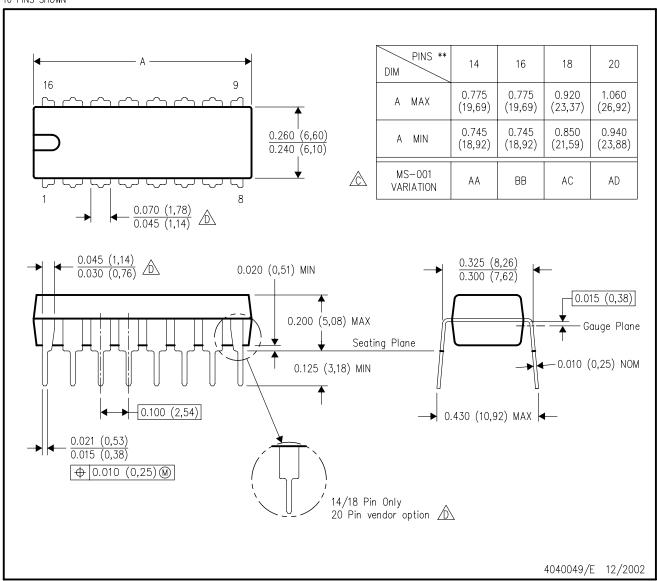
*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
SN75123N	N	PDIP	16	25	506	13.97	11230	4.32

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



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